FSC-BT826

4.2 Dual Mode Bluetooth Module Data Sheet

Document Type: FSC-BT826

Document Version: V1.8.1

Release Date: August 26. 2022

Contact Us

Shenzhen Feasycom Co., LTD

Email: sales@feasycom.com

Address: Rm 508, Building A, Fenghuang Zhigu, No.50, Tiezai Road, Xixiang, Baoan District, Shenzhen, 518102, China
Tel: 86-755-27924639

Release Record

Version Number	Release Date	Comments
Revision 1.0	2014-11-5	First Release
Revision 1.1	2015-09-09	
Revision 1.2	2016-03-24	1, Modified BT Status for 33 pin, 2, Modify the application circuit diagram.
Revision 1.3	2016-04-16	1, Modify the Pin 9 ,10 , 14, 16 , 17,28,31 function definition. 2, Modify the application circuit diagram. 3, This version of the specification is applicable to V1.2 version of the PCB.
Revision 1.4	2016-08-06	1, PIN27 Alternative Function :BT Power Mode 2, Modify the application circuit diagram.
Revision 1.5	2018-05-10	Modify Bluetooth Version: Upgrade from BT4.0 to BT4.2
Revision 1.6	2019-08-29	Add certificate picture
Revision 1.7	2019-10-18	Feature update
Revision 1.8	2020-04-30	Increase power consumption parameters
Revision 1.8.1	2022-08-26	Change the operating temperature: 0ºC to +70 ºC

1. INTRODUCTION

FSC-BT826 is a fully integrated Bluetooth module that complies with Bluetooth 4.2 dual mode protocols(BR/EDR/BLE). It supports SPP, BLE, ANCS, iBeacon, profiles. It integrates Baseband controller in a small package（Integrated chip antenna）, so the designers can have better flexibilities for the product shapes.

FSC-BT826 can be communicated by UART port. With Feasycom's Bluetooth stack, Customers can easily transplant to their software. Please refer to Feasycom stack design guide.

1.1 Block Diagram

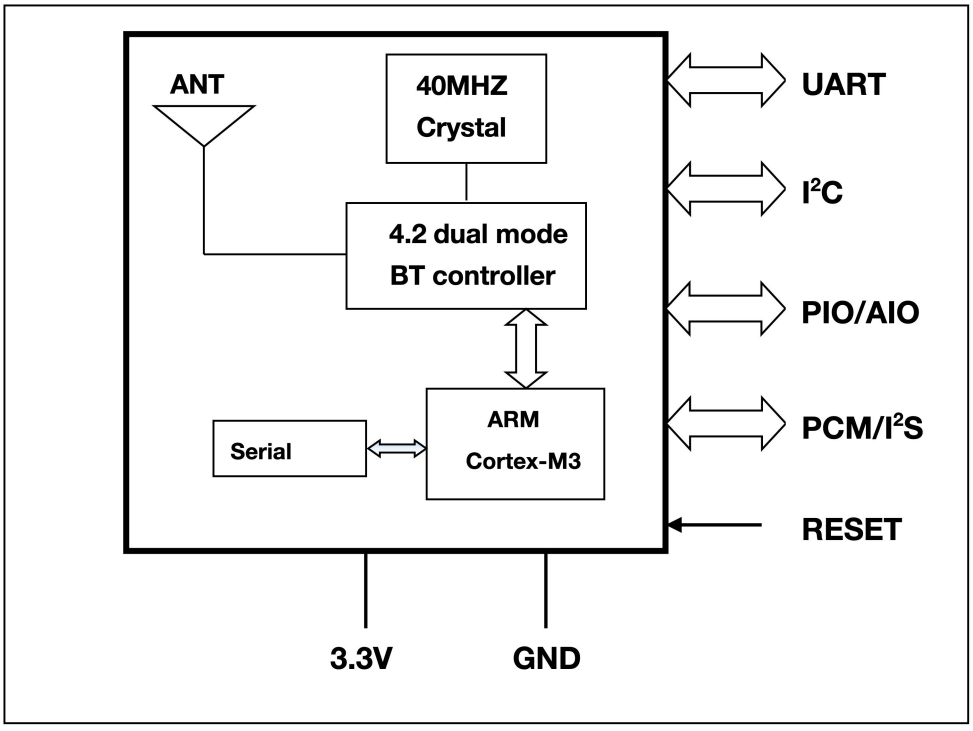


Figure 1

1.2 Feature

- Fully qualified Bluetooth 4.2/4.0/3.0/2.1/2.0/1.2/1.1
- Postage stamp sized form factor.
- Low power.
- Class 1.5 support(high output power)
- The default UART Baud rate is 115.2Kbps and can support from 1200bps up to 921Kbps,.
- UART, I^2C,PCM / I^2S data connection interfaces.
- Support the OTA upgrade.
- Bluetooth stack profiles support: SPP, HID, MAP, and all BLE protocols.
- BQB, SRRC, ROHS and Airsync Certified.
- Power Consumption In Working Mode (VDD_3V3 at 3.3 V)
  - Discoverable：18.5mA
  - BR/EDR Connection：22.4mA
  - LE Connection：17.9mA
  - BR/EDR Connection @ 115200bps：23.4mA

1.3 Application

- Smart Watch and Bluetooth Bracelet
- Health & Medical devices
- Wireless POS
- Measurement and monitoring systems
- Industrial sensors and controls
- Asset Tracking

2. GENERAL SPECIFICATION

General Specification	
Chipset	Realtek RTL8761
Product	FSC-BT826
Dimension	13mm x 26.9mm x 2mm
Bluetooth Specification	Bluetooth V4.2 (Dual Mode)
Power Supply	3.3 Volt DC
Output Power	5.5 dBm
Sensitivity	-82dBm@0.1%BER
Frequency Band	2.402GHz -2.480GHz ISM band
Modulation	FHSS,GFSK,DPSK,DQPSK
Baseband Crystal OSC	40MHz
Hopping & channels	1600hops/sec, 1MHz channel space,79 Channels(BT 4.2 to 2MHz channel space)
RF Input Impedance	50 ohms
Antenna	Integrated chip antenna
Interface	Data: UART, I^2C, PCM / I^2S
Profile	SPP, GATT(BLE Standard) MFI,Airsync,ANCS, iBeacon, MAP(optional),OTA(optional)
Temperature	0ºC to +70 ºC
Humidity	10%~95% Non-Condensing
Environmental	RoHS Compliant

Table 1

3. PHYSICAL CHARACTERISTIC

FSC-BT826 dimension is 26.9mm(L)x13mm(W)x2mm(H).

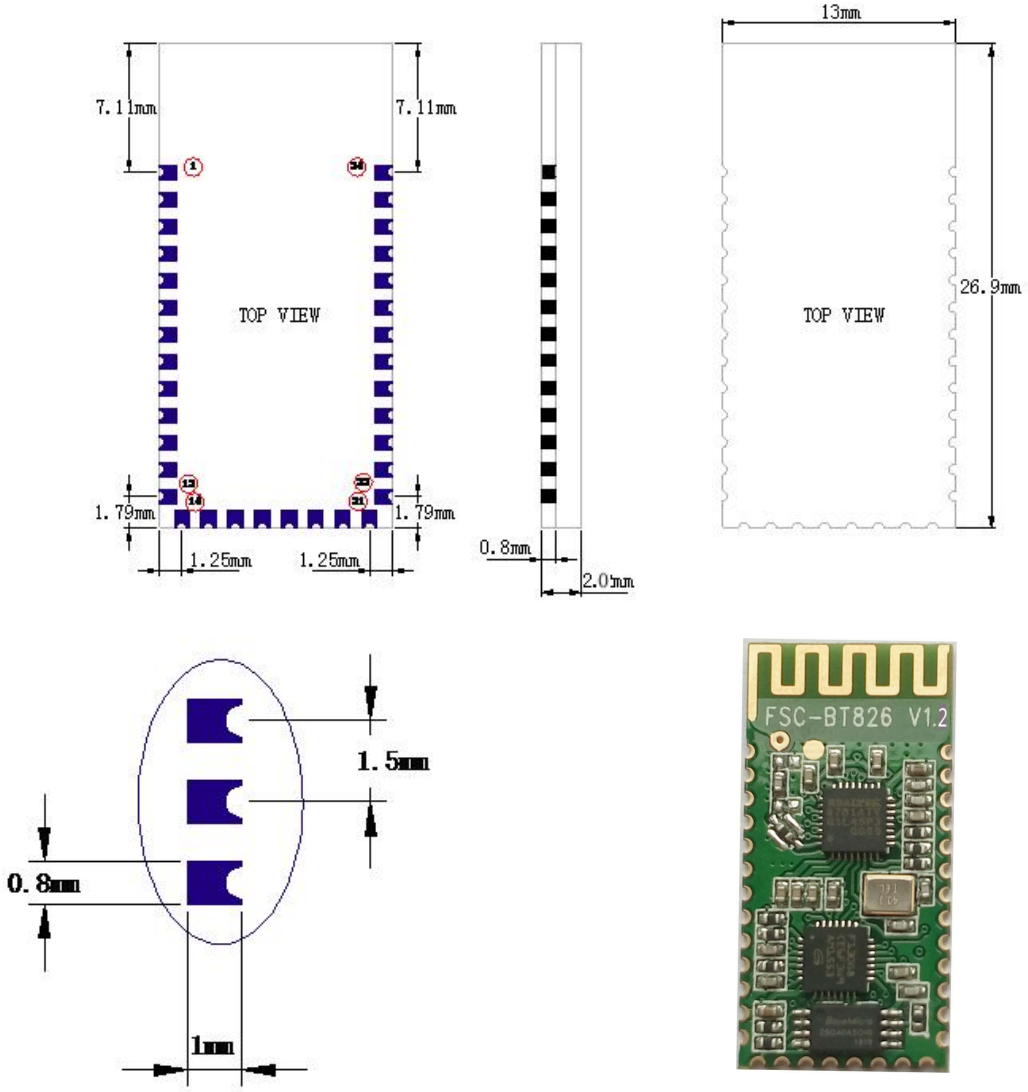


Figure 2: Package Dimensions（TOP VIEW）

4. PIN DEFINITION DESCRIPTIONS

* **Special tips:** PIO0,PIO1,PIO2,PIO3 I/O port for reuse.

When using the OTA function upgrade (air), please send the I/O mouth dangling;

If the I/O port to connect the MCU,

then set the MCU I/O ports for the input port or high impedance state.

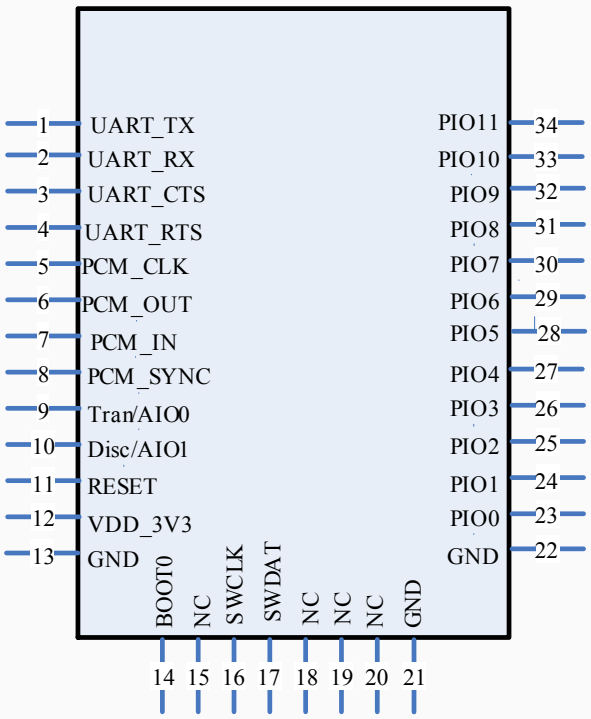


Figure 3: PIN description

Pin	Pin Name	Pad Type	Description
1	UART_TX	CMOS output	UART data output
2	UART_RX	CMOS input	UART data input
3	UART_CTS	CMOS input	UART clear to send active low Alternative Function: Programmable input/output line
4	UART_RTS	CMOS output	UART request to send active low Alternative Function: Programmable input/output line
5	PCM_CLK	Bi-directional	Synchronous data clock
6	PCM_OUT	CMOS Output	Synchronous data output
7	PCM_IN	CMOS Input	Synchronous data input

8	PCM_SYNC	Bi-directional	Synchronous data Sync
9	Tran/AIO0	I/O	Host MCU change UART transmission mode. (Default) Alternative Function: Analogue programmable I/O line.
10	Disc/AIO1	I/O	Host MCU disconnect bluetooth. (Default). Alternative Function: Analogue programmable I/O line.
11	RESET	CMOS input	Reset if low. Input debounced so must be low for >5ms to cause a reset.
12	VDD_3V3	VDD	Power supply voltage 3.3V
13	GND	VSS	Power Ground
14	BOOT0	Bi-directional	The default is low. (internal 10K resistance drop) UART DFU Mode, Enabled at startup when set to high level, Disabled by default
15	NC	NC	NC
16	SWCLK	Bi-directional	Debugging through the clk line(Default)
17	SWDIO	Bi-directional	Debugging through the data line(Default)
18	NC	NC	NC
19	NC	NC	NC
20	NC	NC	NC
21	GND	VSS	Power Ground
22	GND	VSS	Power Ground
23	**PIO0**	I/O	Programmable input/output line *** The I/O port for reuse.**
24	**PIO1**	I/O	Programmable input/output line *** The I/O port for reuse.**
25	**PIO2**	I/O	Programmable input/output line *** The I/O port for reuse.**
26	**PIO3**	I/O	Programmable input/output line *** The I/O port for reuse.**
27	PIO4	I/O	Programmable input/output line Alternative Function: BT Power Mode, low level in run mode, it will be set to high level when fall asleep.
28	**PIO5**	I/O	***With the use of the Pin 9.***

29	PIO6	I/O	Programmable input/output line Alternative Function: I²C CLK line (Default)
30	PIO7	I/O	Programmable input/output line Alternative Function: I²C DATA line (Default)
31	**PIO8**	I/O	***With the use of the Pin 10.***
32	PIO9	I/O	Programmable input/output line Alternative Function: LED(Default)
33	PIO10	I/O	Programmable input/output line Alternative Function: BT Status(Default)
34	PIO11	I/O	Programmable input/output line

Table 2

5. Interface Characteristics

5.1 UART Interface

Four signals are used to implement the UART function. When FSC-BT826 is connected to another digital device, UART_RX and UART_TX transfer data between the two devices. The remaining two signals, UART_CTS and UART_RTS, can be used to implement RS232 hardware flow control where both are active low indicators.

The interface consists of four-line connection as described in below:

Signal name	Driving source	Description
UART-TX	FSC-BT826 module	Data from FSC-BT826 module
UART-RX	Host	Data from Host
UART-RTS	FSC-BT826 module	Request to send output of FSC-BT826 module
UART-CTS	Host	Clear to send input of FSC-BT826 module

Table 3

Default Data Format

Property	Possible Values
BCSP-Specific Hardware	Enable
Baud Rate	115. 2 Kbps
Flow Control	None
Data bit length	8bit
Parity	None

Number of Stop Bits	1

Table 4

5.2 I²C Interface

- Up to two I²C bus interfaces can support both master and slave mode with a frequency up to 400KHZ.
- Provide arbitration function, optional PEC(packet error checking) generation and checking.
- Supports 7 –bit and 10 –bit addressing mode and general call addressing mode.

The I²C interface is an internal circuit allowing communication with an external I²C interface which is an industry standard two line serial interface used for connection to external hardware. These two serial lines are known as a serial data line (SDA) and a serial clock line (SCL). The I²C module provides two data transfer rates: 100 kHz of standard mode or 400kHz of the fast mode. The I²C module also has an arbitration detect function to prevent the situation where more than one master attempts to transmit data to the I²C bus at the same time. A CRC-8 calculator is also provided in I²C interface to perform packet error checking for I²C data.

5.3 Analog to digital converter (ADC)

- 12-bit SAR ADC engine with up to 1 MSPS conversion rate
- Conversion range: VSSA to VDDA (2.6 to 3.6 V)
- Temperature sensor

One 12-bit 1 µs multi-channel ADC is integrated in the device.
The conversion range is between 2.6 V < VDDA < 3.6 V. An analog watchdog block can be used to detect the channels, which are required to remain within a specific threshold window. A configurable channel management block of analog inputs also can be used to perform conversions in single, continuous, scan or discontinuous mode to support more advanced usages. The ADC can be triggered from the events generated by the general-purpose timers (TMx) and the advanced-control timers (TM1) with internal connection.
The temperature sensor can be used to generate a voltage that varies linearly with temperature. Each device is factory-calibrated to improve the accuracy and the calibration data are stored in the system memory area.

5.4 PCM Interface Characteristics

The FSC-BT826 supports a PCM digital audio interface that is used for transmitting digital audio/voice data to/from the Audio Codec. Features are supported as below

- Supports Master and Slave mode
- Programmable long/short Frame Sync
- Supports 8-bit A-law/µ-law, and 13/16-bit linear PCM formats
- Supports sign-extension and zero-padding for 8-bit and 13-bit samples
- Supports padding of Audio Gain to 13-bit samples
- PCM Master Clock Output: 64, 128, 256, or 512kHz
- Supports SCO/ESCO link

5.4.1 PCM Format

FrameSync is the synchronizing function used to control the transfer of DAC_Data and ADC_Data. A Long FrameSync indicates the start of ADC_Data at the rising edge of FrameSync (Figure 3), and a Short FrameSync indicates the start of ADC_Data at the falling edge of FrameSync (Figure 4).

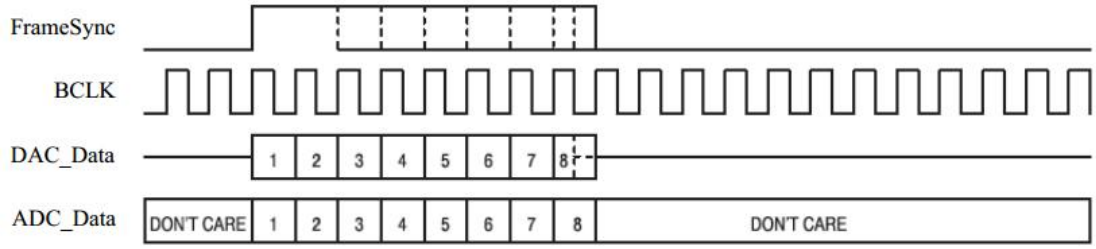


Figure 4: Long FrameSync

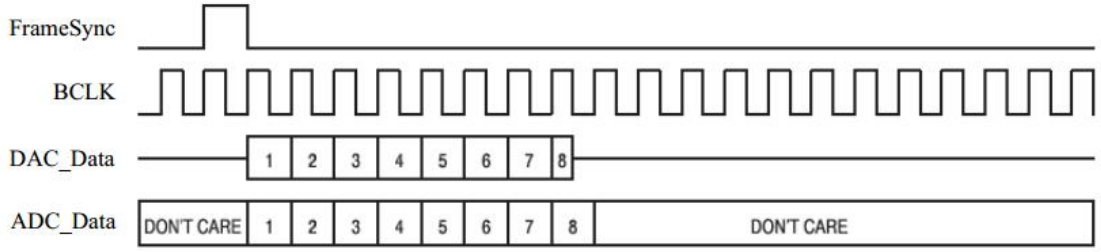


Figure 5: Short FrameSync

5.4.2 Sign Extension and Zero Padding for 8-Bit and 13-Bit Samples

For 16-bit linear PCM output, 3 or 8 unused bits may be sign extended/zero padded.

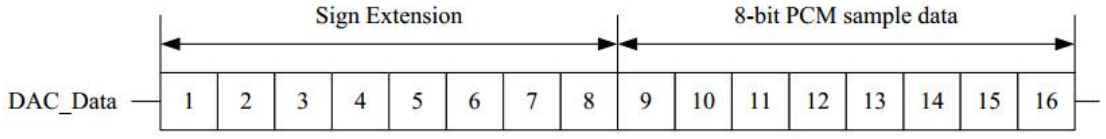


Figure 6: 16-Bit Output Data with 8-Bit PCM Sample Data and Sign Extension

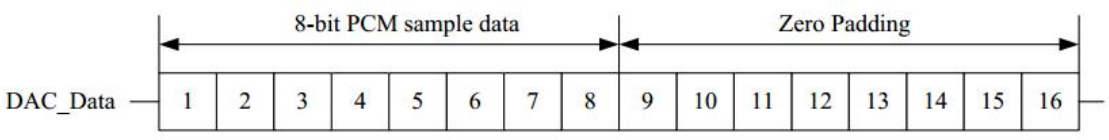


Figure 7: 16-Bit Output Data with 8-Bit PCM Sample Data and Zero Padding

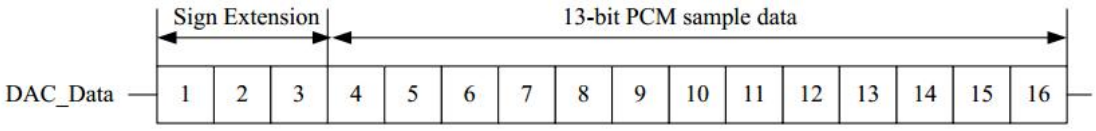


Figure 8: 16-Bit Output Data with 13-Bit PCM Sample Data and Sign Extension

For 16-bit linear PCM output, 3-bit programmable audio gain value can be padded to 13-bit sample data.

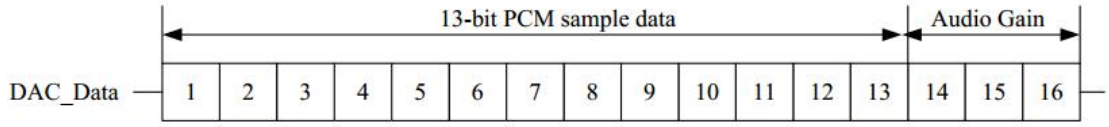


Figure 9: 16-Bit Output Data with 13-Bit PCM Sample Data and Audio Gain

5.4.3 PCM Interface Timing

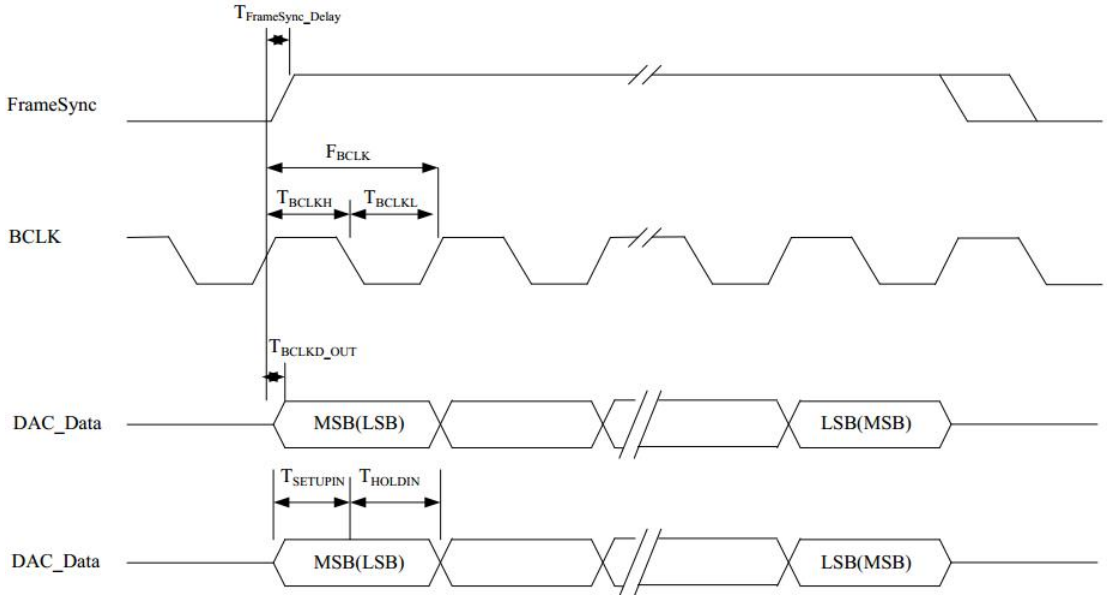


Figure 10: PCM Interface (Long FrameSync)

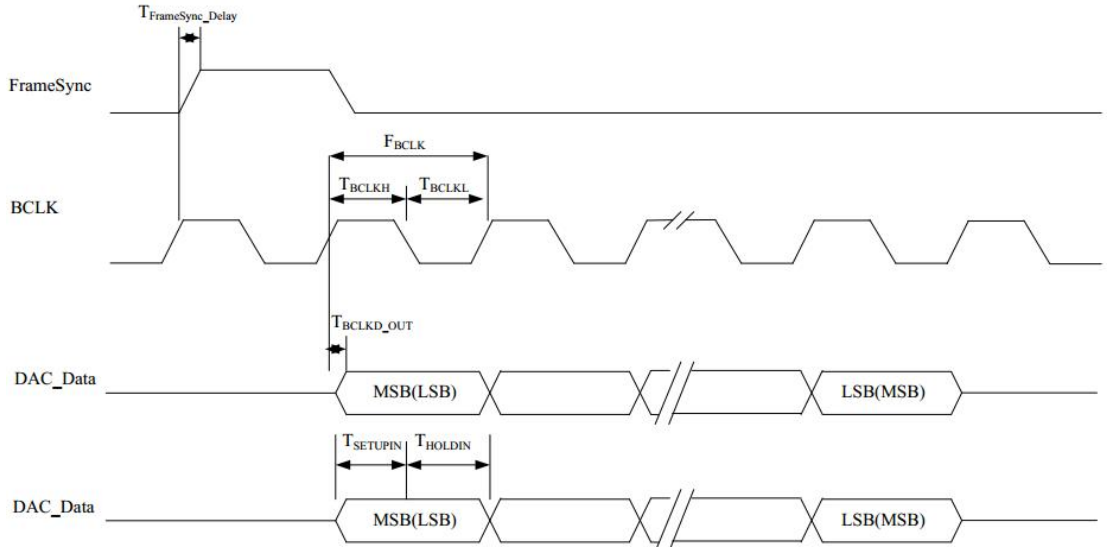


Figure 11: PCM Interface (Short FrameSync)

Symbol	Description	Min.	Typ.	Max.	Unit
F_{BCLK}	Frequency of BCLK (Master)	64	-	512	kHz
$F_{FrameSync}$	Frequency of Frame Sync (Master)	-	8	-	kHz
F_{BCLK}	Frequency of BCLK (Slave)	64	-	512	kHz
$F_{FrameSync}$	Frequency of Frame Sync (Slave)	-	8	-	kHz
D	Data Size	8	8	16	bits
N	Number of Slots Per Frame	1	1	1	Slots

Table 5: PCM Interface Clock Specifications

Symbol	Description	Min.	Typ.	Max.	Unit
T_{BCLKH}	High Period of BCLK	980	-	-	ns
T_{BCLKL}	Low Period of BCLK	970	-	-	ns
$T_{FrameSync\_Delay}$	Delay Time from BCLK High to Frame Sync High	-	-	75	ns
T_{BCLKD_OUT}	Delay Time from BCLK High to Valid DAC_Data	-	-	125	ns
$T_{SETUPIN}$	Set-up Time for ADC_Data Valid to BCLK Low	10	-	-	ns
T_{HOLDIN}	Hold Time for BCLK Low to ADC_Data Invalid	125	-	-	ns

Table 6: PCM Interface Timing

5.4.4 PCM Interface Signal Levels

The PCM signal level ranges from 1.8V to 3.3V.

6. RECOMMENDED TEMPERATURE REFLOW PROFILE

The re-flow profiles are illustrated in Figure 11 and Figure 12 below.

- Follow: IPC/JEDEC J-STD-020 C
- Condition:
  - Average ramp-up rate(217℃ to peak):1~2℃/sec max.
  - Preheat:150~200C,60~180 seconds
  - Temperature maintained above 217℃:60~150 seconds
  - Time within 5℃ of actual peak temperature:20~40 sec.
  - Peak temperature:250+0/-5℃ or 260+0/-5℃
  - Ramp-down rate:3℃/sec.max.
  - Time 25℃ to peak temperature:8 minutes max
  - Cycloe interval： 5 minus

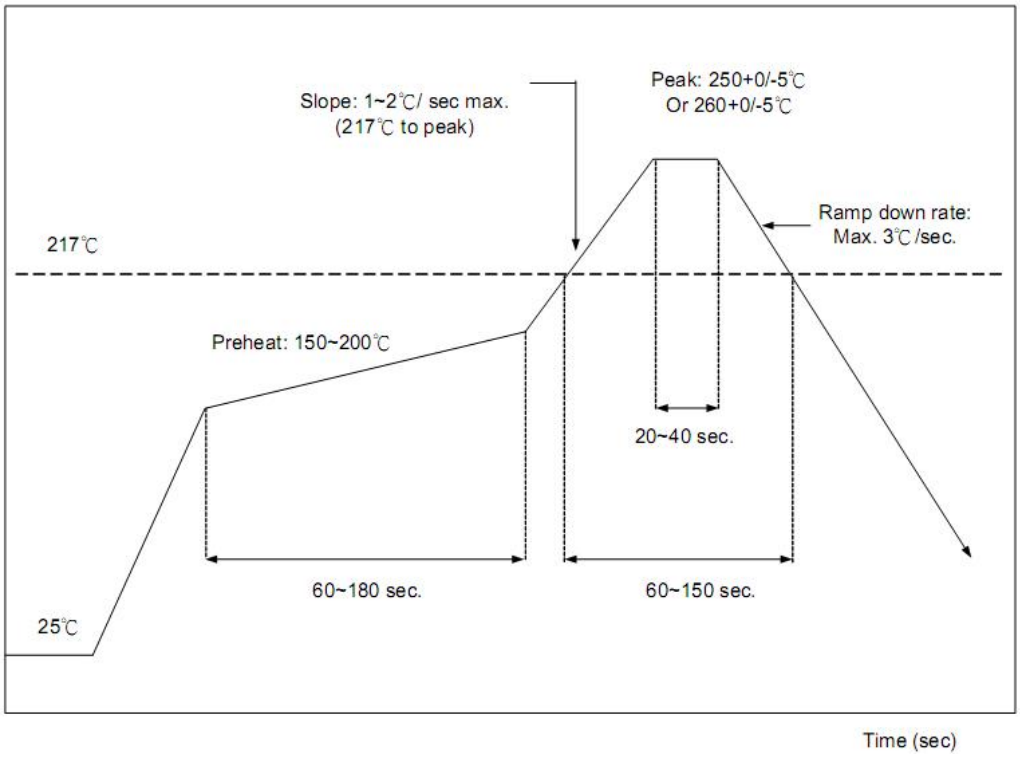


Figure 12: Typical Lead-free Re-flow Solder Profile

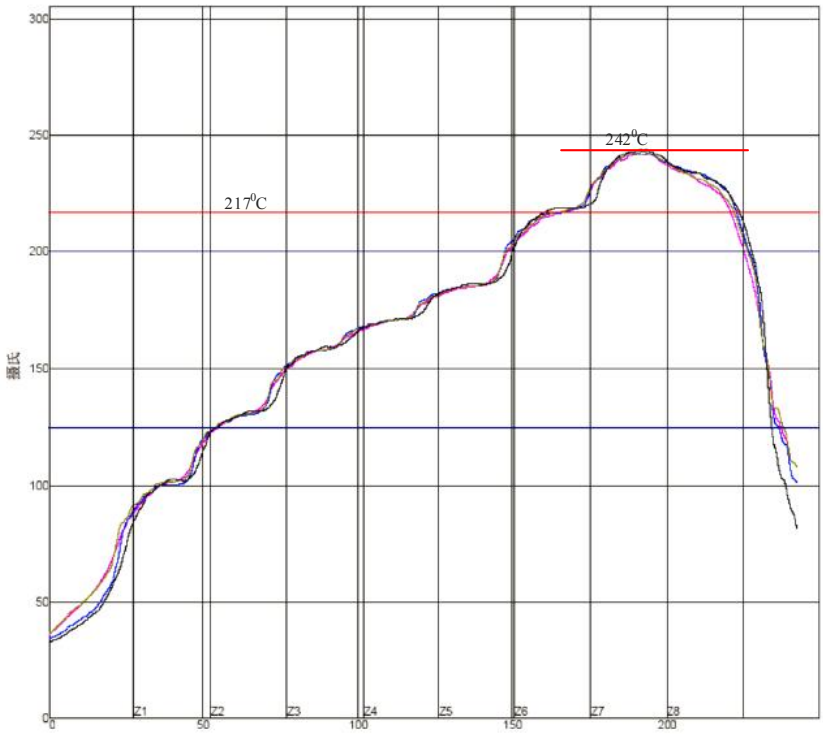


Figure 13 : Typical Lead-free Re-flow

The soldering profile depends on various parameters according to the use of different solder and material. The data here is given only for guidance on solder re-flow.

FSC-BT826 will withstand up to two re-flows to a maximum temperature of 245°C.

7. Reliability and Environmental Specification

7.1 Temperature test

Put the module in demo board which uses exit power supply, power on the module and connect to mobile. Then put the demo in the 0℃ space for 1 hour and then move to +70℃ space within 1minute, after 1 hour move back to 0℃ space within1 minute. This is 1 cycle. The cycles are 32 times and the units have to pass the testing.

7.2 Vibration Test

The module is being tested without package. The displacement requests 1.5mm and sample is vibrated in three directions(X,Y,Z).Vibration frequency set as 0.5G , a sweep rate of 0.1 octave/min from 5Hz to 100Hz last for 90 minutes each direction. Vibration frequency set as 1.5G, a sweep rate of 0.25 octave/min from 100Hz to 500Hz last for 20 minutes each direction.

7.3 Desquamation test

Use clamp to fix the module, measure the pull of the component in the module, make

sure the module`s soldering is good.

7.4 Drop test

Free fall the module (condition built in a wrapper which can defend ESD) from 150cm height to cement ground, each side twice, total twelve times. The appearance will not be damaged and all functions OK.

7.5 Packaging information

After unpacking, the module should be stored in environment as follows:

- Temperature: 25°C ± 2°C
- Humidity: <60%
- No acidity, sulfur or chlorine environment

The module must be used in four days after unpacking.

8. Layout and Soldering Considerations

8.1 Soldering Recommendations

FSC-BT826 is compatible with industrial standard reflow profile for Pb-free solders. The reflow profile used is dependent on the thermal mass of the entire populated PCB, heat transfer efficiency of the oven and particular type of solder paste used. Consult the datasheet of particular solder paste for profile configurations.

Feasycom will give following recommendations for soldering the module to ensure reliable solder joint and operation of the module after soldering. Since the profile used is process and layout dependent, the optimum profile should be studied case by case. Thus following recommendation should be taken as a starting point guide.

8.2 Layout Guidelines

It is strongly recommended to use good layout practices to ensure proper operation of the module. Placing copper or any metal near antenna deteriorates its operation by having effect on the matching properties. Metal shield around the antenna will prevent the radiation and thus metal case should not be used with the module. Use grounding vias separated max 3 mm apart at the edge of grounding areas to prevent RF penetrating inside the PCB and causing an unintentional resonator. Use GND vias all around the PCB edges.

The mother board should have no bare conductors or vias in this restricted area, because

it is not covered by stop mask print. Also no copper (planes, traces or vias) are allowed in this area, because of mismatching the on-board antenna.

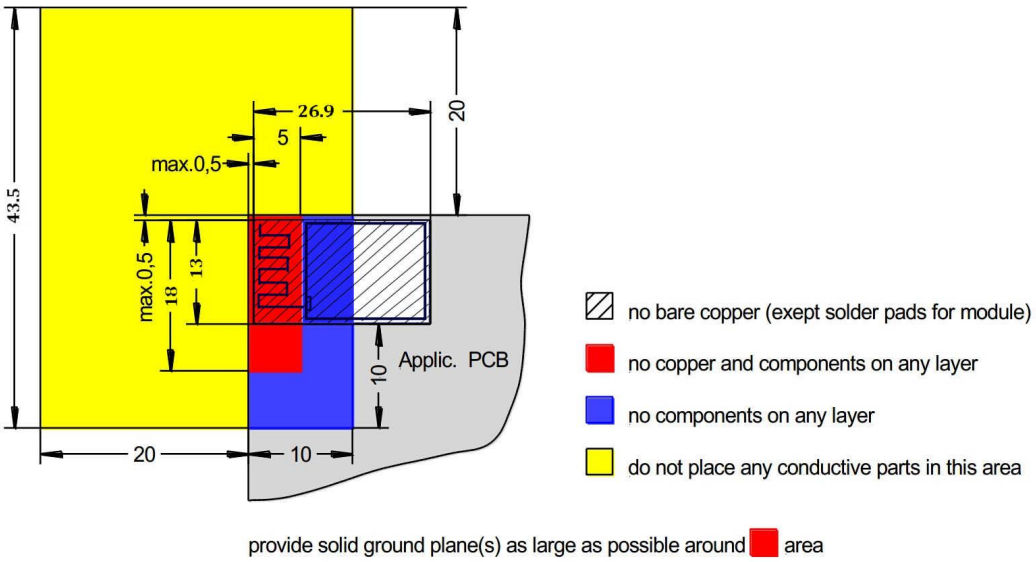


Figure 14: FSC-BT826 Restricted Area

Following recommendations helps to avoid EMC problems arising in the design. Note that each design is unique and the following list do not consider all basic design rules such as avoiding capacitive coupling between signal lines. Following list is aimed to avoid EMC problems caused by RF part of the module. Use good consideration to avoid problems arising from digital signals in the design.

Ensure that signal lines have return paths as short as possible. For example if a signal goes to an inner layer through a via, always use ground vias around it. Locate them tightly and symmetrically around the signal vias. Routing of any sensitive signals should be done in the inner layers of the PCB. Sensitive traces should have a ground area above and under the line. If this is not possible, make sure that the return path is short by other means (for example using a ground line next to the signal line).

9. Certificate

Has passed BQB, SRRC, ROHS and Airsync certification.

QDL Bluetooth® qualified design listing

The Bluetooth SIG Hereby Recognizes

Shenzhen Feasycom Technology Co., Ltd.
Member Company

Bluetooth module
Qualified Design Name

Declaration ID: D033894
Qualified Design ID: 92203
Specification Name: 4.0
Project Type: End Product
Model Number: FSC-BT826
Listing Date: 06 January 2017
Assessment Date: 06 January 2017
Hardware Version Number: V1.3
Software Version Number: 5.2.3,20160930

This certificate acknowledges the *Bluetooth*® Specifications declared by the member are achieved in accordance with the Bluetooth Qualification Process as specified within the Bluetooth Specifications and as required within the current PRD

Bluetooth®

无线电发射设备
Radio Transmission Equipment
型号核准证
Type Approval Certificate

深圳市飞易通科技有限公司：

根据《中华人民共和国无线电管理
In accordance with the provisions on the Radio
条例》，经审查，下列无线电发射设备
Regulations of the People's Republic of China , the following
符合中华人民共和国无线电管理规定和
radio transmission equipment , after examination , conforms
技术标准，其核准代码为：CMIIT ID:2019DP4046
to the provisions with its CMIIT ID:

有效期：五年
Validity

中华人民共和国工业和信息化部
（发证机关）
Sealed by issuing authority
2019年 6月 4日
Year Month Date

编号：2019-4046
Number

设备名称：蓝牙模块
Equipment Name

设备型号：FSC-BT826
Equipment Type

主要功能：数据传输
Main Functions

调制方式：GFSK π/4 DQPSK 8DPSK
Modulation Mode

主要技术参数及其指标值：
Main Technical Parameters

频率范围：2400-2483.5MHz
Frequency Range

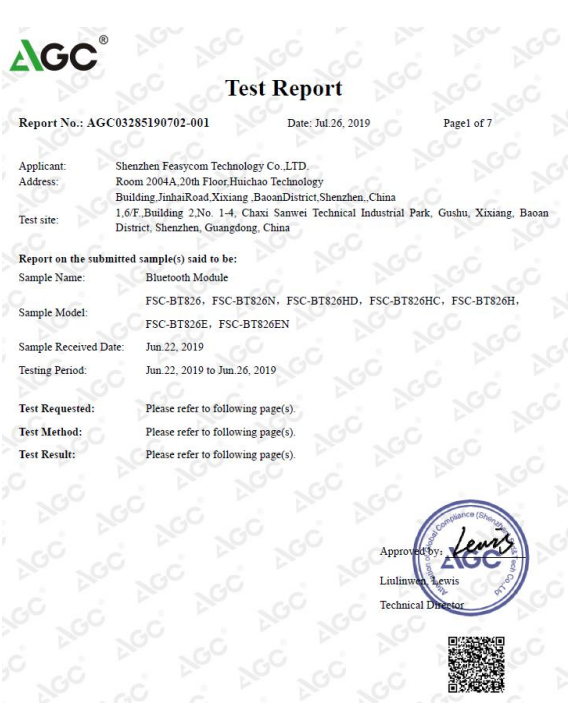
频率容限：≤20ppm
Frequency Tolerance

发射功率：≤20dBm(EIRP)
Transmitting Power

占用带宽：≤2MHz
Occupied Bandwidth

杂散发射限值：≤-30dBm
Spurious Emission Limits

信息化部无线电
（核发单位章）
Sealed by issuing authority
2019年 6月 4日
Year Month Date



AGC®

Test Report

Report No.: AGC03285190702-001 Date: Jul.26, 2019 Page1 of 7

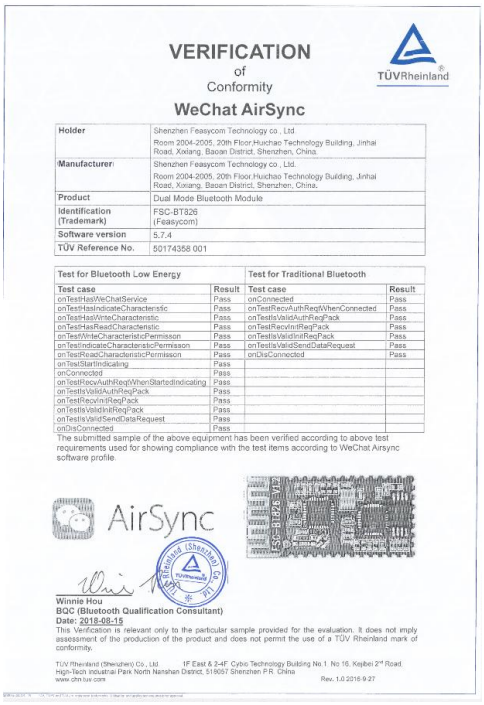
Applicant: Shenzhen Feasycom Technology Co.,LTD.
Address: Room 2004A,20th Floor,Huichao Technology Building,JinhaiRoad,Xixiang ,BaoanDistrict,Shenzhen, China
Test site: 1,6/F.,Building 2,No. 1-4, Chaxi Sanwei Technical Industrial Park, Gushu, Xixiang, Baoan District, Shenzhen, Guangdong, China

Report on the submitted sample(s) said to be:

Sample Name: Bluetooth Module
Sample Model: FSC-BT826，FSC-BT826N，FSC-BT826HD，FSC-BT826HC，FSC-BT826H，FSC-BT826E，FSC-BT826EN
Sample Received Date: Jun.22, 2019
Testing Period: Jun.22, 2019 to Jun.26, 2019

Test Requested: Please refer to following page(s).
Test Method: Please refer to following page(s).
Test Result: Please refer to following page(s).

Approved by:
Liulinwen ,Lewis
Technical Director



VERIFICATION
of
Conformity
WeChat AirSync

TÜVRheinland®

Holder	Shenzhen Feasycom Technology co., Ltd. Room 2004-2005, 20th Floor,Huichao Technology Building, Jinhai Road, Xixiang, Baoan District, Shenzhen, China.
Manufacturer	Shenzhen Feasycom Technology co., Ltd. Room 2004-2005, 20th Floor,Huichao Technology Building, Jinhai Road, Xixiang, Baoan District, Shenzhen, China.
Product	Dual Mode Bluetooth Module
Identification (Trademark)	FSC-BT826 (Feasycom)
Software version	5.7.4
TÜV Reference No.	50174358 001

Test for Bluetooth Low Energy		Test for Traditional Bluetooth	
Test case	Result	Test case	Result
onTestHasWeChatService	Pass	onConnected	Pass
onTestHasIndicateCharacteristic	Pass	onTestRecvAuthReqWhenConnected	Pass
onTestHasWriteCharacteristic	Pass	onTestIsValidAuthReqPack	Pass
onTestHasReadCharacteristic	Pass	onTestRecvInitReqPack	Pass
onTestWriteCharacteristicPermisson	Pass	onTestIsValidInitReqPack	Pass
onTestIndicateCharacteristicPermisson	Pass	onTestIsValidSendDataRequest	Pass
onTestReadCharacteristicPermisson	Pass	onDisConnected	Pass
onTestStartIndicating	Pass		
onConnected	Pass		
onTestRecvAuthReqWhenStartedIndicating	Pass		
onTestIsValidAuthReqPack	Pass		
onTestRecvInitReqPack	Pass		
onTestIsValidInitReqPack	Pass		
onTestIsValidSendDataRequest	Pass		
onDisConnected	Pass		

The submitted sample of the above equipment has been verified according to above test requirements used for showing compliance with the test items according to WeChat Airsync software profile.

AirSync

Winnie Hou
BQC (Bluetooth Qualification Consultant)
Date: 2018-08-15

This Verification is relevant only to the particular sample provided for the evaluation. It does not imply assessment of the production of the product and does not permit the use of a TÜV Rheinland mark of conformity.

TÜV Rheinland (Shenzhen) Co., Ltd. 1F East & 3-4F Cybio Technology Building No.1 No.16, Keyuan 2nd Road, High-Tech Industrial Park North Nanshan District, 518057 Shenzhen P.R. China
www.chn.tuv.com
Rev. 1.0 2016-9-27

10. Application Schematic